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New Desktop Electroplating System

For In-House Prototyping

Wilsonville, OR, February 1, 2007– LPKF Laser & Electronics introduces the **MiniContac RS**, reverse pulse plating system, specially developed for the professional production of prototype and small batch production PCBs. This cost-effective system is completely enclosed in a compact table top size, ideal for any rapid PCB prototyping situation, especially small runs and tight work locations, such as a research environment.

Utilizing reverse pulse plating (RPP) technology allows uniform metal distribution for more aggressive aspect ratios. The **MiniContac RS** has the ability to plate holes as small as 8 mil (0.2 mm) vias in 62 mil thick standard PCBs smoothly; thin or fragile materials can easily be placed in a support framework before processing. The **MiniContac RS** handles circuit boards as large as 9" x 13" (230 mm x 330 mm) and is completely closed with no external connection needed. Allowing double-sided and multilayer boards to quickly and easily be through-hole plated. North American Vice President Jim Greene said, "The MiniContac is simple and easy to operate. It uses safe chemicals to make plated through-holes and does not require special operation skills. This system takes advantage of the Reverse Pulse Plate technology, for a clean, perfect through-hole plating process."

The **MiniContac RS** uses only four tanks, which can easily be replaced when required. For ease of use LPKF handles the complete disposal of all plating chemicals. This system features LPKF's standard approach to prototype plating solutions, favoring simple maintenance of chemical assets, and semi-automated menu-driven control system.



www.lpkfusa.com/images/products/mcrs.jpg

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